

METHOD FOR RESIN MOLDING AND RESIN MOLDING APPARATUS

ABSTRACT

The method is capable of resin-molding one side face of a work (W) in a molding die set (1), in which the work (W) is sucked and held on at least one of clamping faces and resin-molded in a cavity concave section (4). The method comprises the steps of: sucking and holding a release film (12) which covers at least one of the clamping faces of the molding die set (1); setting the work (W) in the molding die set (1); sucking the other side face of the work (W) through a work sucking hole (12g) of the release film (12), which is formed before or after holding the release film (12), so as to hold the work (W) on the clamping face; closing the molding die set (1) so as to clamp the work (W); and pressurizing and heating the resin (24), which has been accommodated in the cavity concave section (4), with resin (24).

FIGURE 2